

### Rad-hard plastic Quad two-input AND gate



### **Features**

- AND gate
- 1.65 V to 6 V operating supply
- 7 V max. rating
- 8.5 ns propagation delay
- Nickel/Palladium/Gold-lead-finished (NiPdAu), whisker-free
- · Gold-wires
- RML < 1% and CVCM < 0.1% guaranteed outgassing</li>
- 50 krad (Si) Total Ionizing Dose
- SEL-free up to 62.5 MeV.cm²/mg
- Mass: 80 mg
- Compliant with ST-LEO-specification

### **Maturity status link**

LEOAC08

### **Applications**

· Low earth orbit (LEO) applications

### **Description**

The LEOAC08 is a CMOS low power quad 2-input AND gate qualified for use in aerospace environments. It operates from 1.65 V to 6 V power supply (7 V absolute maximum rating).

The LEOAC08 can operate over a large temperature range of -40 °C to +125 °C and it is housed in plastic TSSOP-20, Thin-Shrink Small Outline Package, 20 leads, using golden bonding and Nickel/Palladium/Golden-lead-finishing to prevent whiskers.

The LEOAC08 is compliant with ST-LEO-specification, dedicated specification for space-ready rad-hard plastic products. This AEC-Q100-based specification offers a specific trade-off between footprint size savings, cost of ownership and quality assurance together with radiation hardness and large quantity capability.



# Functional description

20 VCC 1A [ 19 3A 1B [ 18 3B 1Y 3 17 3Y 2A 4 2B 5 16 4A 2Y 6 15 4B NC 7 14 4Y NC 8 13 NC NC 9 12 NC GND 10 11 NC

Figure 1. Pin connections (top view)

NC: not internally connected.

The pin can be externally connected to any potential.

Each gate INPUT (A) INPUT (B) OUTPUT (Y) L L L Н L L Н L L Н Н Н

Table 1. Truth table

with: L = low level, H = high Level.

For all inputs,  $V_{IN} = V_{IH}$  minimum or  $V_{IL}$  maximum, verify output  $V_{OUT}$ .

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# 2 Maximum ratings and operating conditions

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CC</sub> <sup>(1)</sup>	Maximum power supply between V <sub>CC</sub> and GND	-0.5 to 7	V
V <sub>IN</sub>	DC input voltage range	-0.5 to V <sub>CC</sub> +0.5 (and 7 V max.)	V
V <sub>OUT</sub>	DC output voltage range	-0.5 to V <sub>CC</sub> + 0.5 (and 7 V max.)	V
I <sub>K</sub>	I/O clamp diode current	+/-20	mA
T <sub>stg</sub>	Maximum temperature storage	-65 to +150	°C
T <sub>j</sub> (2)	Maximum junction temperature	+150	°C
R <sub>th</sub> <sup>(3)</sup>	Junction to ambient thermal resistance $(\Theta_{ja})$	80	°C/W
K <sub>th</sub> (°)	Junction to case thermal resistance ( $\Theta_{jc}$ )	17	°C/W
ESD	HBM (human body model)	2k	V
LSD	CDM (charged device model)	1k	V

<sup>1.</sup> All voltages, except differential I/O bus voltage, are with respect to the network ground terminal .

**Table 3. Operating conditions** 

Symbol	Parameter	Min.	Max.	Unit
V <sub>CC</sub>	Analog supply voltage	1.65	6	V
V <sub>IN</sub>	Input voltage range	0	V <sub>CC</sub>	V
V <sub>OUT</sub>	Output voltage range	0	V <sub>CC</sub>	V
Та	Ambient temperature range	-40	+125	°C

Note: All unused inputs must be held at  $V_{CC}$  or GND to ensure proper device operation.

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<sup>2.</sup> Maximum junction temperature shall not be exceeded except for allowable short duration burn-in screening conditions as per the method 5004 of MIL-STD-883.

<sup>3.</sup> Short-circuits can cause excessive heating. Destructive dissipation can result from short-circuits on the amplifiers.

## 3 Electrical characteristics

 $V_{CC}$  = 3 V to 5.5 V, typical values are at ambient Ta = +25 °C, min. and max. values are at Ta = -40 °C and +125 °C, unless otherwise specified.

**Table 4. Electrical characteristics** 

Symbol	Parameter	Test condition	VCC (V)	Min.	Тур.	Max.	Unit	
		For all inputs affecting output under test, V <sub>IN</sub>	3	2.9				
		= V <sub>IH</sub> minimum or V <sub>IL</sub> maximum. For all other inputs,	4.5	4.4				
		$V_{IN} = V_{CC}$ or GND, $I_{OH} = -50 \mu A$	5.5	5.4				
V <sub>OH</sub> <sup>(1)</sup>	High level output	For all inputs affecting output under test, $V_{IN}$ = $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND, $I_{OH}$ = -12 mA	3	3 2.4		V		
	voltage	For all inputs affecting output under test, V <sub>IN</sub>	4.5	3.7				
		= $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND, $I_{OH}$ = -24 mA	5.5	4.7				
		For all inputs affecting output under test, $V_{IN}$ = $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND $I_{OH}$ = -50 mA	5.5	3.85				
		For all inputs affecting output under test, V <sub>IN</sub>	3		0.1			
		= V <sub>IH</sub> minimum or V <sub>IL</sub> maximum. For all other	4.5		0.1			
		inputs, $V_{IN} = V_{CC}$ or GND, $I_{OL} = +50 \mu A$	5.5		0.1		V	
V <sub>OL</sub> <sup>(1)</sup>	Low level output voltage	For all inputs affecting output under test, $V_{IN}$ = $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND, $I_{OL}$ = +12 mA	3		0.5			
	Zon iovol output voltago	For all inputs affecting output under test, V <sub>IN</sub>	4.5		0.5			
		= $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND, $I_{OL}$ = +24 mA	5.5		0.5	0.5		
		For all inputs affecting output under test, $V_{IN}$ = $V_{IH}$ minimum or $V_{IL}$ maximum. For all other inputs, $V_{IN}$ = $V_{CC}$ or GND, $I_{OL}$ = +50 mA	5.5		1.65			
			3	-12				
$I_{OH}$	High level output current		4.5	-24				
	Surrent Control of the Control of th		5.5	-24			^	
			3			12	mA	
$I_{OL}$	Low level output current		4.5			24		
			5.5			24		
			3	2.1				
$V_{IH}^{\ (2)}$	High level input voltage		4.5	3.15			mA	
			5.5	3.85				
			3			0.9		
$V_{IL}^{(2)}$	Low level input voltage		4.5			1.35	V	
			5.5			1.65	1	
V <sub>IC+</sub>	Positive input clamp voltage	For input under test, I <sub>IN</sub> = -1.0 mA	0	0.4		1.5	V	

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Symbol	Parameter	Test condition	VCC (V)	Min.	Тур.	Max.	Unit
V <sub>IC-</sub>	Negative input clamp voltage	For input under test, I <sub>IN</sub> = -1.0 mA	Open	0.4		1.5	V
I <sub>IH</sub>	Input current high	For input under test, $V_{IN} = V_{CC}$ For all other inputs, $V_{IN} = V_{CC}$ or GND	5.5			1	μA
I <sub>IL</sub>	Input current low	For input under test, $V_{IN}$ = GND For all other inputs, $V_{IN}$ = $V_{CC}$ or GND	5			-1	μA
Іссн	$I_{CCH}$ Quiescent supply current, output high For all inputs, $V_{IN} = V_{CC}$ or		5.5			40	μA
I <sub>CCL</sub>	Quiescent supply current, output low	For all inputs, V <sub>IN</sub> = V <sub>CC</sub> or GND I <sub>OUT</sub> = 0 A	5.5			40	μA
C <sub>IN</sub> (3)	Input capacitance	Ta = +25 °C	5			10	pF
C <sub>PD</sub> (4)	Power dissipation capacitance	Ta = +25 °C, F = 1 MHz	5			88	pF
		$C_1 = 2 \text{ pF}, R_1 = 500 \text{ ohm (see Figure 2)}$	3		3.3		
T <sub>r</sub> , T <sub>f</sub>	Output rise time and fall	ot - 2 pr, rt - 300 onin (see right 2)	4.5		2.7		ns
1,, 1,	time	C <sub>1</sub> = 50 pF, R <sub>1</sub> = 500 ohm (see Figure 2)	3		4.6		113
		CL = 50 pr, RL = 500 onin (see Figure 2)	4.5		3.3		
T <sub>PHL</sub> (5)	Propagation delay time	$C_L = 50 \text{ pF}, R_L = 500 \text{ ohm (see Figure 2)}$	3	1		11.5	
PHL	An to Yn, high to low	OL - 30 pr , INL - 300 Offili (See Figure 2)	4.5	1		8.5	ns
T <sub>PLH</sub> <sup>(5)</sup>	Propagation delay time	C <sub>1</sub> = 50 pF, R <sub>1</sub> = 500 ohm (see Figure 2)	3	1		12.5	113
<sup>I</sup> PLH <sup>(o)</sup>	An to Yn, low to high		4.5	1		9	

- 1. The  $V_{OH}$  and  $V_{OL}$  tests shall be tested at  $V_{CC}$  = 3.0 V and 4.5 V. The  $V_{OH}$  and  $V_{OL}$  tests are guaranteed, if not tested, for other values of  $V_{CC}$ . Limits shown apply to operation at  $V_{CC}$  = 3.3 V,  $\pm$ 0.3 V and  $V_{CC}$  = 5.0 V  $\pm$ 0.5 V. Tests with input current at  $\pm$ 50 mA and  $\pm$ 50 mA are performed on only one input at a time with duration not to exceed 10 ms. Transmission driving tests may be performed using  $V_{IN} = V_{CC}$  or GND. When  $V_{IN} = V_{CC}$  or GND is used, the test is guaranteed for  $V_{IN} = V_{IH}$  minimum and  $V_{IL}$  maximum.
- 2. The  $V_{IH}$  and  $V_{IL}$  tests are not required if applied as forcing functions for  $V_{OH}$  and  $V_{OL}$  tests.
- 3. C<sub>IN</sub> and C<sub>PD</sub> shall be measured only for initial qualification and after process or design changes which may affect capacitance. C<sub>IN</sub> shall be measured between the designated terminal and GND at a frequency of 1 MHz. C<sub>PD</sub> shall be tested in accordance with the latest revision of JEDEC Standard JESD20 and table IA herein. For C<sub>IN</sub> and C<sub>PD</sub>, test all applicable pins on five devices with zero failures.
- 4. Power dissipation capacitance (C<sub>PD</sub>) determines both the power consumption (P<sub>D</sub>) and dynamic current consumption (IS). Where: P<sub>D</sub> = (C<sub>PD</sub> + C<sub>L</sub>) (V<sub>CC</sub> x V<sub>CC</sub>) f + (I<sub>CC</sub> x V<sub>CC</sub>) and IS = (C<sub>PD</sub> + C<sub>L</sub>) V<sub>CC</sub> x f + I<sub>CC</sub>, and f is the frequency of the input signal and C<sub>L</sub> is the external output load capacitance.
- 5. For propagation delay tests, all paths are tested. The AC limits at  $V_{CC}$  = 5.5 V are equal to the limits at  $V_{CC}$  = 4.5 V and guaranteed by testing at  $V_{CC}$  = 4.5 V. The AC limits at  $V_{CC}$  = 3.6 V are equal to the limits at  $V_{CC}$  = 3.0 V and guaranteed by testing at  $V_{CC}$  = 3.0 V. Minimum AC limits for  $V_{CC}$  = 5.5 V and  $V_{CC}$  = 3.6 V are 1.0 ns and guaranteed by guard banding the  $V_{CC}$  = 4.5 V and  $V_{CC}$  = 3.0 V minimum limits, respectively, to 1.5 ns. For propagation delay tests, all paths must be tested.

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### 4 Waveform and test circuit

Figure 2. Waveform

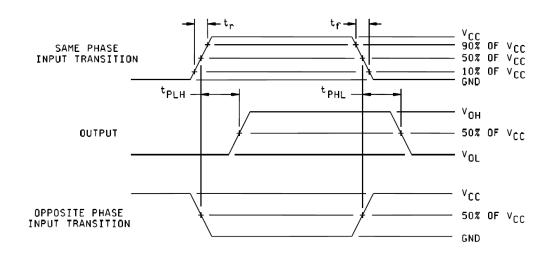
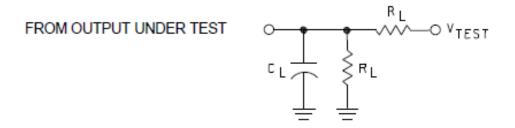


Figure 3. Test circuit



Note:

- $V_{TEST}$  = open for  $t_{PLH}$  and  $t_{PHL}$ .
- $C_L = 50 \text{ pF}$  or equivalent (includes probe and jig capacitance).
- $R_L = 500$ -ohm or equivalent.
- Input signal from pulse generator:  $V_{IN}$  = 0.0 V to  $V_{CC}$ ;  $P_{RR}$  < 1 MHz; ZO = 50-ohm; tr < 3.0 ns; tr and tf shall be measured from 10% of  $V_{CC}$  to 90% of  $V_{CC}$  and from 90% of  $V_{CC}$  to 10% of  $V_{CC}$ , respectively; duty cycle = 50 percent.
- Timing parameters shall be tested at a minimum input frequency of 1 MHz.
- The outputs are measured one at a time with one transition per measurement.

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### 5 Radiations

#### Total ionizing dose (TID):

For the qualification, the product is characterized in TID as per MIL-STD-883 TM 1019 up to 50 krad (Si) on 5 biased parts at high dose rate, such a rate being the worst condition for a pure CMOS technology.

All parameters provided in Table 1 apply to both pre- and post-irradiation.

Each new production lot is tested at high dose rate as per MIL-STD-883 TM 1019 on 5 parts.

#### Heavy-ions:

Single Event Latchup (SEL) is characterized at 125 °C at a LET of 62.5 MeV.cm2/mg. The test shows the product is immune to heavy ions at this LET. Heavy-ion trials are performed on qualification lots only.

The results in radiation are summarized in Table 5 as follows.

Table 5. Radiations

Type	Conditions	Results
TID (1)	<ul> <li>High-dose rate (40 krad (Si) / h)</li> <li>Temperature: 25 °C</li> <li>Performed on 5 biased parts</li> </ul>	WithinTable 1 up to 50 krad(Si)
SEL (2)	<ul> <li>LET: 62.5 MeV.cm2/mg (Xenon ions)</li> <li>Temperature: 125 °C</li> <li>Fluence: 1 x 10<sup>7</sup> ions/cm<sup>2</sup> (10 Million of particles per cm<sup>2</sup>)</li> <li>Normal incidence</li> </ul>	Immune to SEL up to 62.5 MeV.cm <sup>2</sup> /mg (extracted from the LEOAC00, by similarity of architecture)

<sup>1.</sup> A total ionizing dose (TID) of 50 krad(Si) is equivalent to 500 Gy(Si), (1 gray = 100 rad).

2. SEL: single event latch-up

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# 6 Outgassing

Specification (tested per ASTM E 595)		Unit
Recovered mass loss (RML) (1)	0.06	%
Collected volatile condensable material (CVCM) (2)	0.00	%

- 1. RML < 1%
- 2. CVCM < 0.1%

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# 7 Package information

To meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 7.1 TSSOP-20 package information

Figure 4. TSSOP-20 package outline

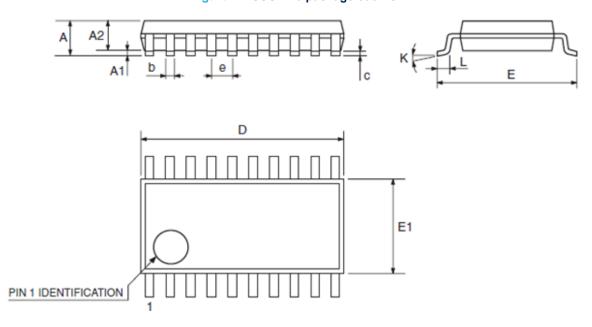


Table 6. TSSOP-20 package mechanical data

Cumbal		Milimeters			Inches <sup>(1)</sup>	
Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		
С	0.09		0.20	0.004		
D	6.4	6.5	6.6	0.252	0.256	0.260
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030

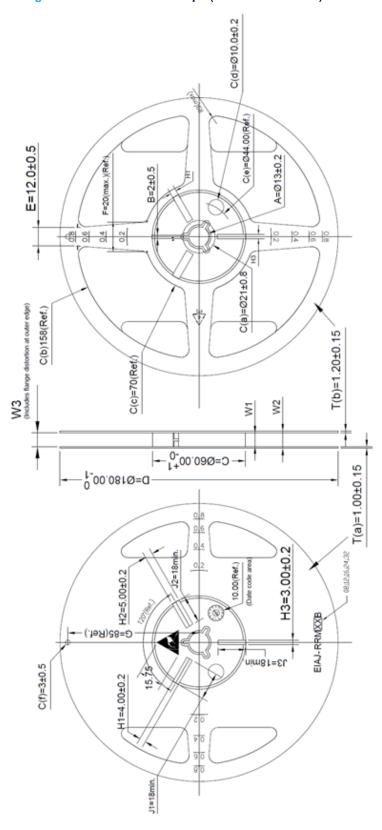
<sup>1.</sup> Values in inches are converted from mm and rounded to 4 decimal digits.

Note: TSSOP: Thin-Shrink Small Outline Package, using golden bonding and Nickel/Palladium/Golden-lead-finishing.

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## 7.2 TSSOP-20 packing information

Figure 5. TSSOP-20 Carrier tape (dimensions in mm) outline



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16.0 ±.3 1.75 ±.10 Ф Ф Φ SECTION B - B Ф Ø 1.5 +0.1/-0.0  $\oplus$ Ф Ф 0 R 0.3 T/P. Ø 1.50 MIN Ф  $\oplus$ 0 6.95 1.80 1.80 1.20  $\oplus$ 7888 |----¥ 8.00 Ф 0 0  $\oplus$ 2.00 ±.10 SE NOTE 3 — 4.00 SE NOTE 1 — NOTES:
1. 10 SPROCKET HOLE PLTCH CUMLATIVE TOLERANCE ±0.2
2. CANGER IN COMPLIANCE WITH EIA 481
3. POCKET POSTITION RELATIVE TO SPROCKET HOLE MEASURED
AS TRUE POSTITION OF POCKET, NOT POCKET HOLE 9. 9. 8 SECTION A -T ±.05 R 0.3 MAX

Figure 6. TSSOP-20 tape (dimensions in mm) outline

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# 8 Ordering information

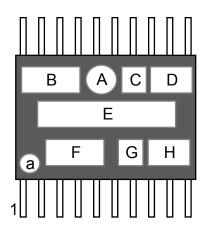
**Table 7. Ordering information** 

Order code	Quality level	Package	Lead-finish	Marking	Packing
LEOAC08PT-D	Development sample	TSSOP-20	NiPdAu	DLEOAC08	Tape and reel
LEOAC08PT	Flight model	TSSOP-20	NiPdAu	LEOAC08	Tape and reel

Table 8. Order code

LEO	AC08	Р	Т
LEO qualification	Name	TSSOP-20 package	Tape and reel

Figure 7. TSSOP-20 marking



- a: pin-1 reference
- A: Second Level of interconnexion (type of lead-finishing)
- B: ST logo
- C: Assy plant
- D: Lot code
- E: Marking area
- F: Country of origin
- G: Assy year
- H: Assy week

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# **Revision history**

Table 9. Document revision history

Date	Version	Changes
10-Jan-2022	1	First release.
01-Feb-2022	2	Removed footnote in Table 7. Ordering information.
04-Oct-2024	3	Updated minimum operating power supply from 2 V to 1.65 V.

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